

FATA

FAst Timing Applications
for nuclear physics and
medical imaging

October 10th, 2025
Catania, Italy

Development of Hybrid and CMOS Monolithic LGADs for the 20 ps TOF detector of the future ALICE 3 experiment at the LHC

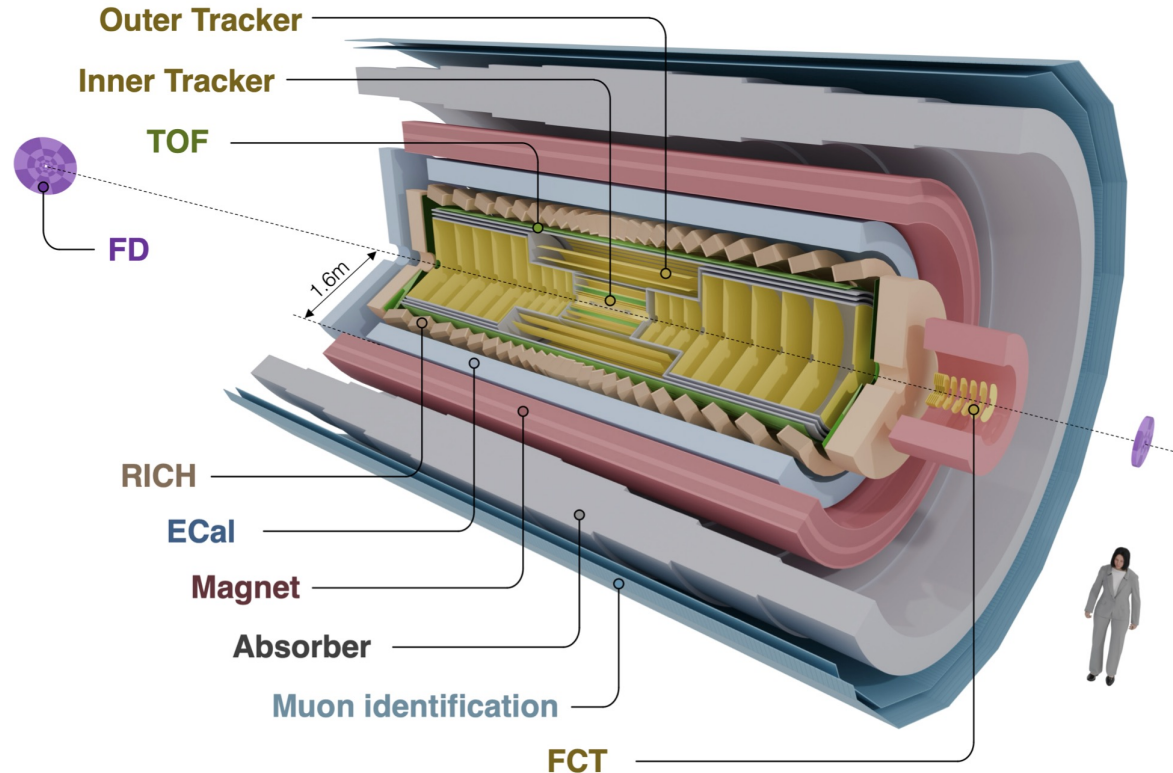
Sofia Strazzi

on behalf of the ALICE Collaboration

University and INFN Bologna, Italy



The ALICE Collaboration has submitted the proposal for a next-generation heavy-ion experiment, ALICE 3, to be installed at the LHC during the LS4 (2034-35)



New, compact, low-mass, experimental apparatus totally based on the **most advanced silicon technologies**

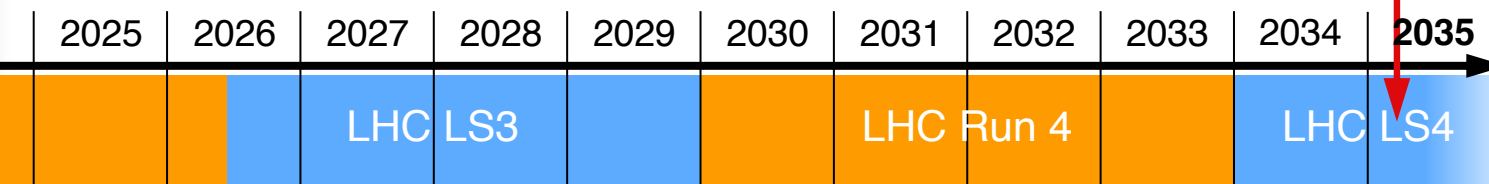
Letter of Intent: <https://arxiv.org/abs/2211.02491>
Scoping Document: <https://cds.cern.ch/record/2925455>

➔ **New exciting opportunities for the study of:**

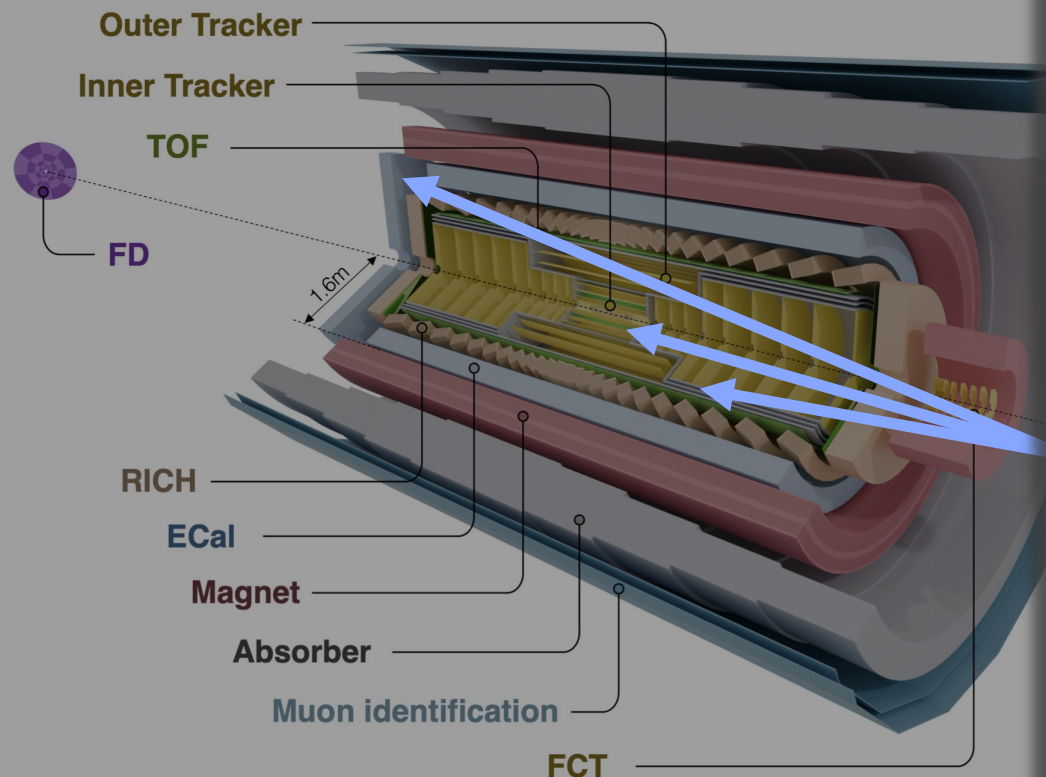
◆ **Multi-charm hadrons at low momenta**
➔ Crucial test for coalescence models

◆ **EM radiation** produced in the first evolution phases of QGP

ALICE 3 a next generation heavy-ion experiment



The ALICE Collaboration has submitted an experiment, ALICE 3, to be installed at the LHC.



ALICE 3 a next generation heavy-ion experiment

2025	2026	2027	2028	2029	2030	2031	2032
		LHC LS3	LHC LS3			LHC Run 4	

Time-Of-Flight System (TOF)

$$\text{Separation Power} \propto \frac{L}{\sigma_{\text{TOF}}}$$

- inner TOF $R \approx 19 \text{ cm}$
- outer TOF $R \approx 85 \text{ cm}$
- forward TOF $z \approx 375 \text{ cm}$

Requirements:

- Moderate rad. hardness
 - inner TOF: $\text{NIEL} \sim 6.1 \cdot 10^{12} \text{ 1-MeV } n_{\text{eq}} / \text{cm}^2$
 - outer TOF: $\text{NIEL} \sim 9 \cdot 10^{11} \text{ 1-MeV } n_{\text{eq}} / \text{cm}^2$
 - forward TOF: $\text{NIEL} \sim 8.5 \cdot 10^{12} \text{ 1-MeV } n_{\text{eq}} / \text{cm}^2$
- Low material budget $\sim 1\text{-}3\% X_0$

Time resolution

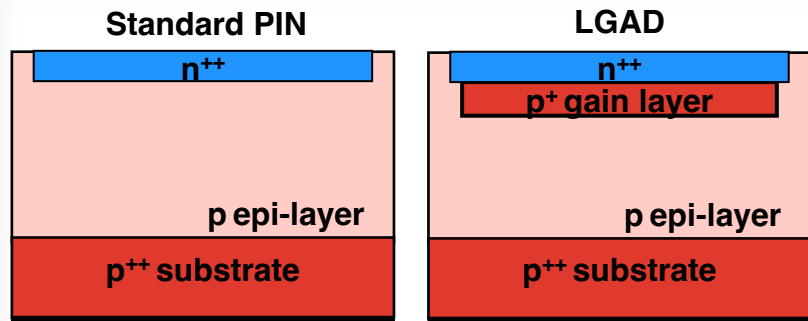
$$\begin{aligned} e/\pi &\lesssim 500 \text{ MeV}/c \\ K/\pi &\lesssim 2.5 \text{ GeV}/c \\ p/K &\lesssim 4 \text{ GeV}/c \end{aligned}$$

20ps

Extensive R&D on the most advanced silicon technologies:

LGADs, SiPMs, CMOS-LGADs

MOTIVATIONS - LOW GAIN AVALANCHE DETECTOR (LGAD)



Electric field

Gain region: very high electric field

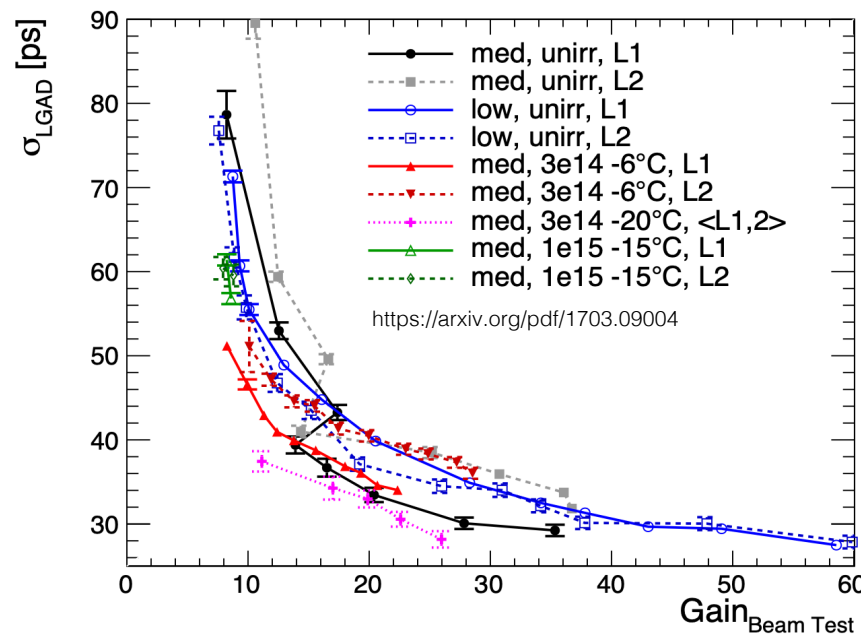
Drift region: low and uniform electric field

Internal low-gain multiplication mechanism

Optimized to obtain:

- Fast signal (dV/dt)
- Improved S/N

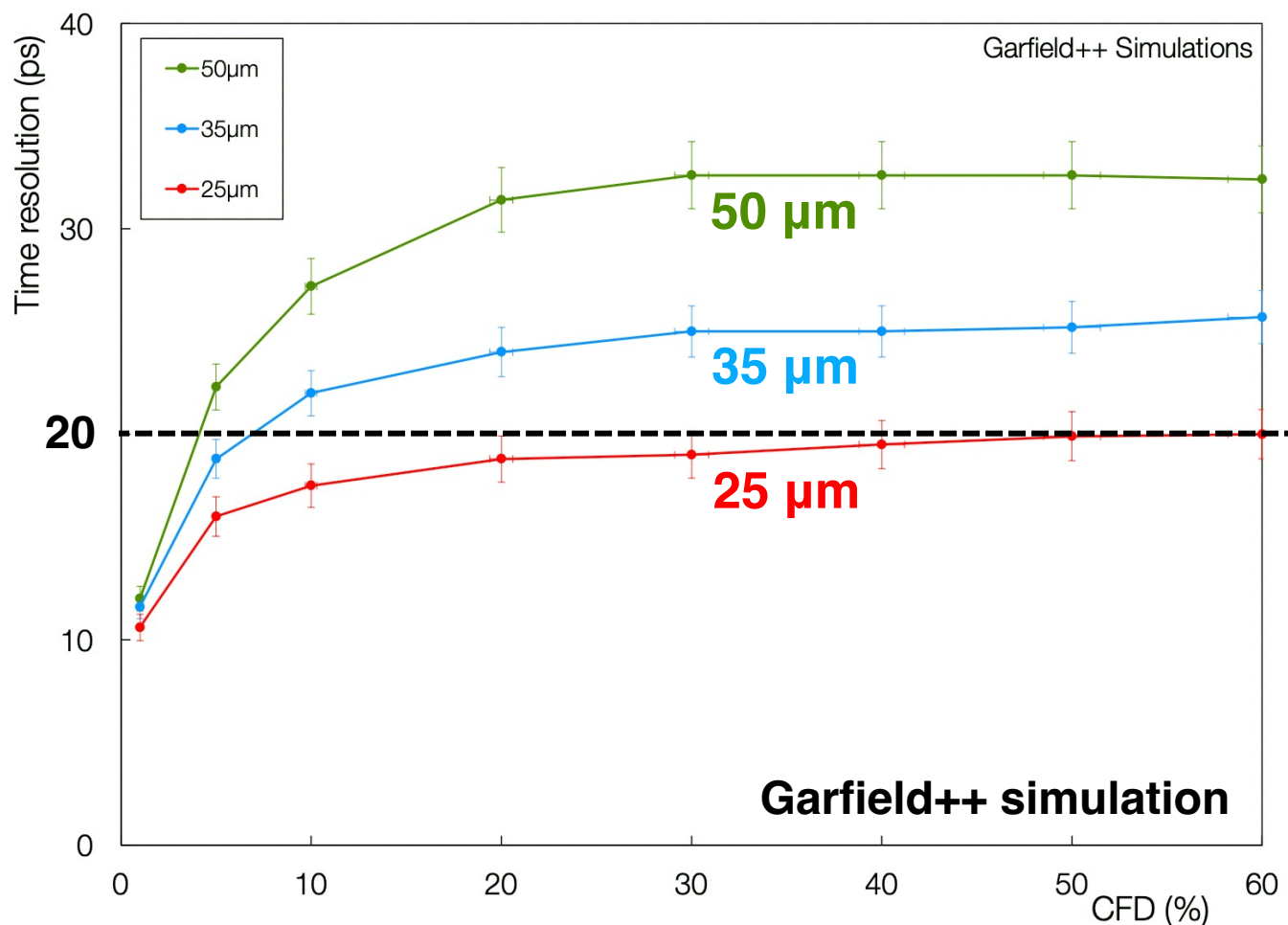
➔ **Excellent timing performance**



State-of-the-art LGAD
(35-50 μm -thick)

➔ **~ 30 ps**

Already used or envisioned for detector upgrades at the HL-LHC (e.g. ATLAS and CMS) for 2026



→ Potential of a thinner layout of LGAD

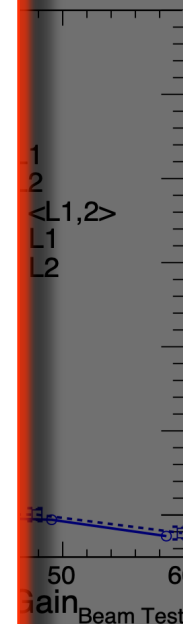
ALICE 3 TOF detector needs an even better time resolution

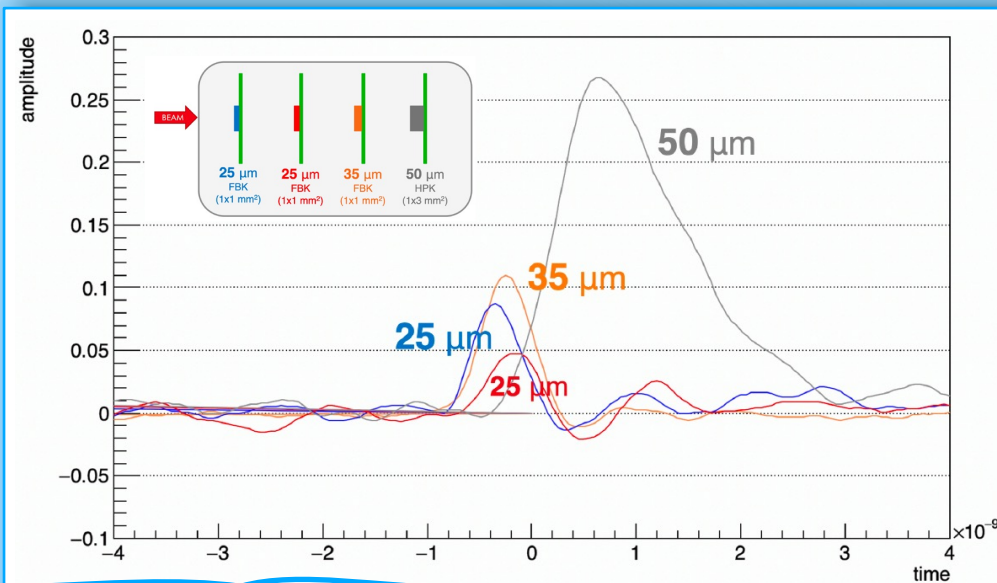
→ **20 ps**

State-of-the-art LGAD (35-50 μm-thick)

→ **~30 ps**

Already used or envisioned for detector upgrades at the HL-LHC (e.g. ATLAS and CMS) for 2026





DIGITAL OSCILLOSCOPE READOUT

- Signal waveforms acquired
- Digitalization at the analysis level



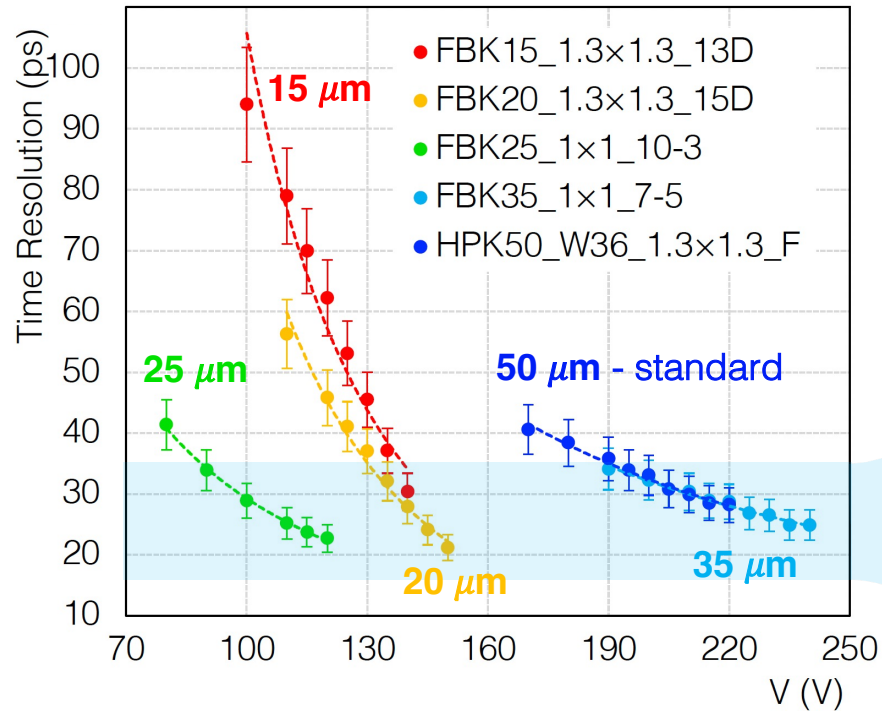
CERN PS



Sensors attached to a Santacruz V1.4-SCIPP-08/18 front-end board **aligned back-to-back to the beam**

Seven beam test campaigns (2021-2024) with a hadron beam of $p \sim 10-12 \text{ GeV/c}$

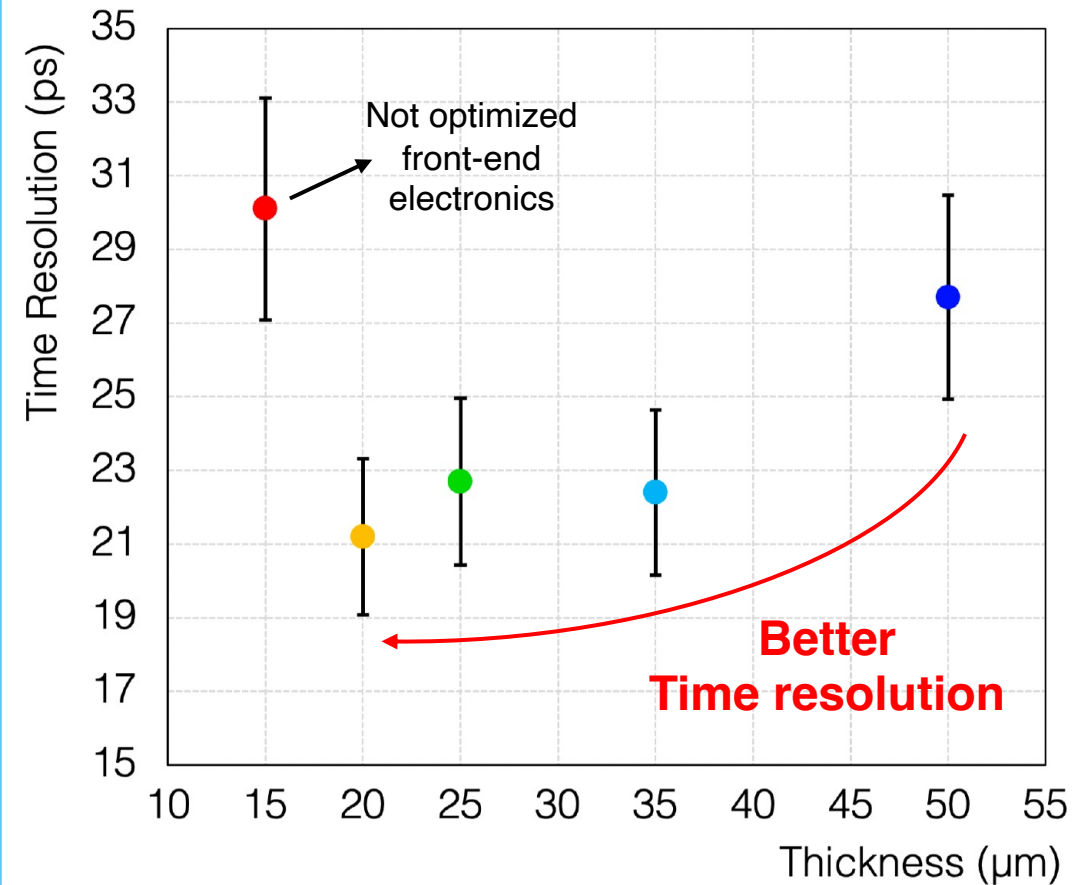
TEST OF THE FIRST VERY THIN LGAD PROTOTYPES



- ◆ 50 μm in line with the expectations
 - Validation of setup and analysis procedure
- ◆ Improved time res. with thinner LGADs
 - All in agreement with MC simulation
 - Slightly worse for the 25 μm due to worse S/N

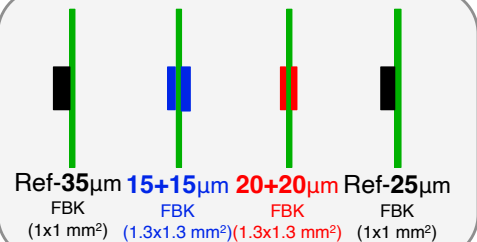
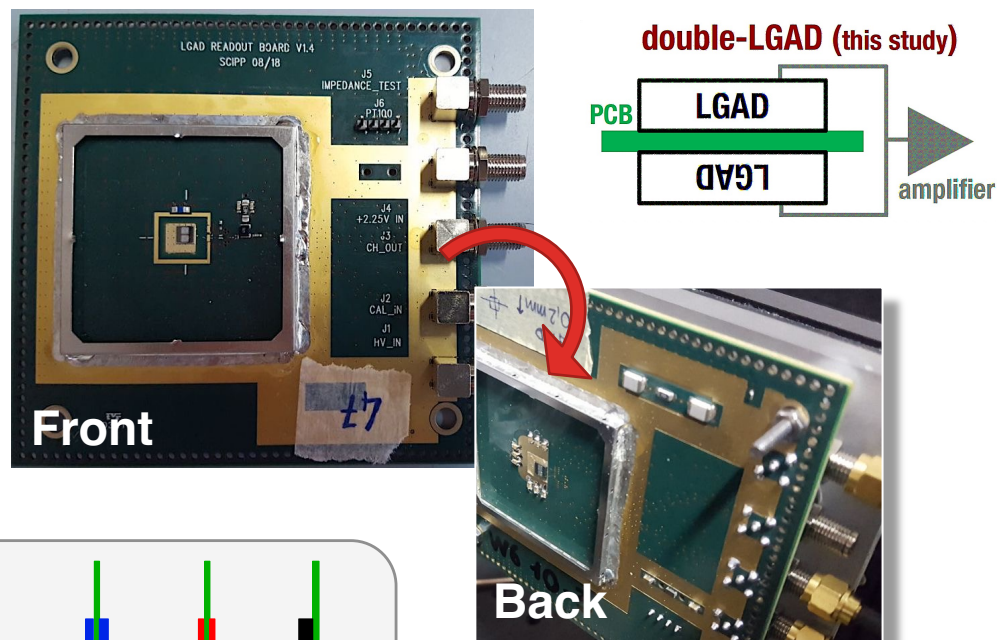
First 15, 20, 25 and 35 μm thick FBK LGADs were tested in a beam test

<https://link.springer.com/article/10.1140/epjp/s13360-022-03619-1>



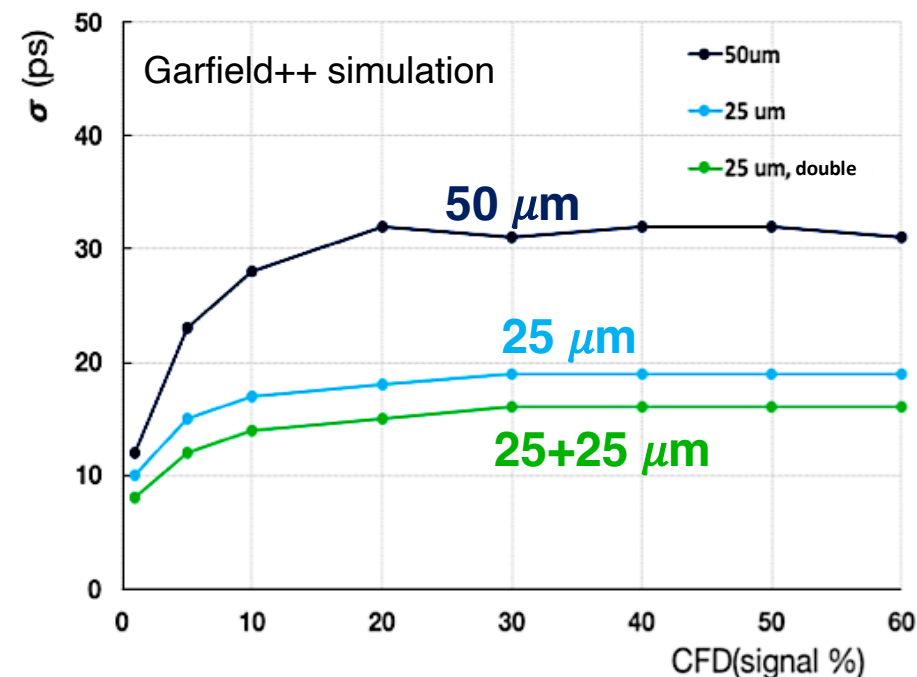
NEW CONCEPT: DOUBLE-LGAD

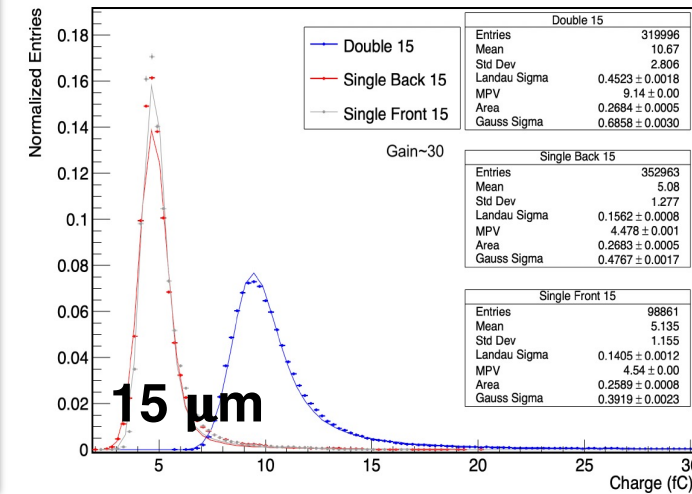
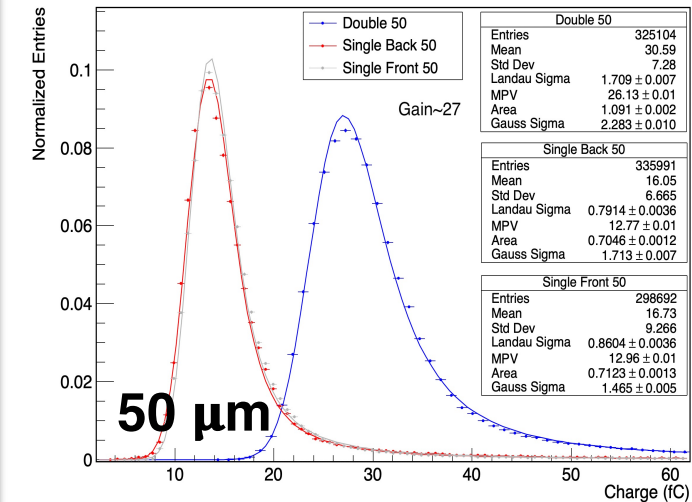
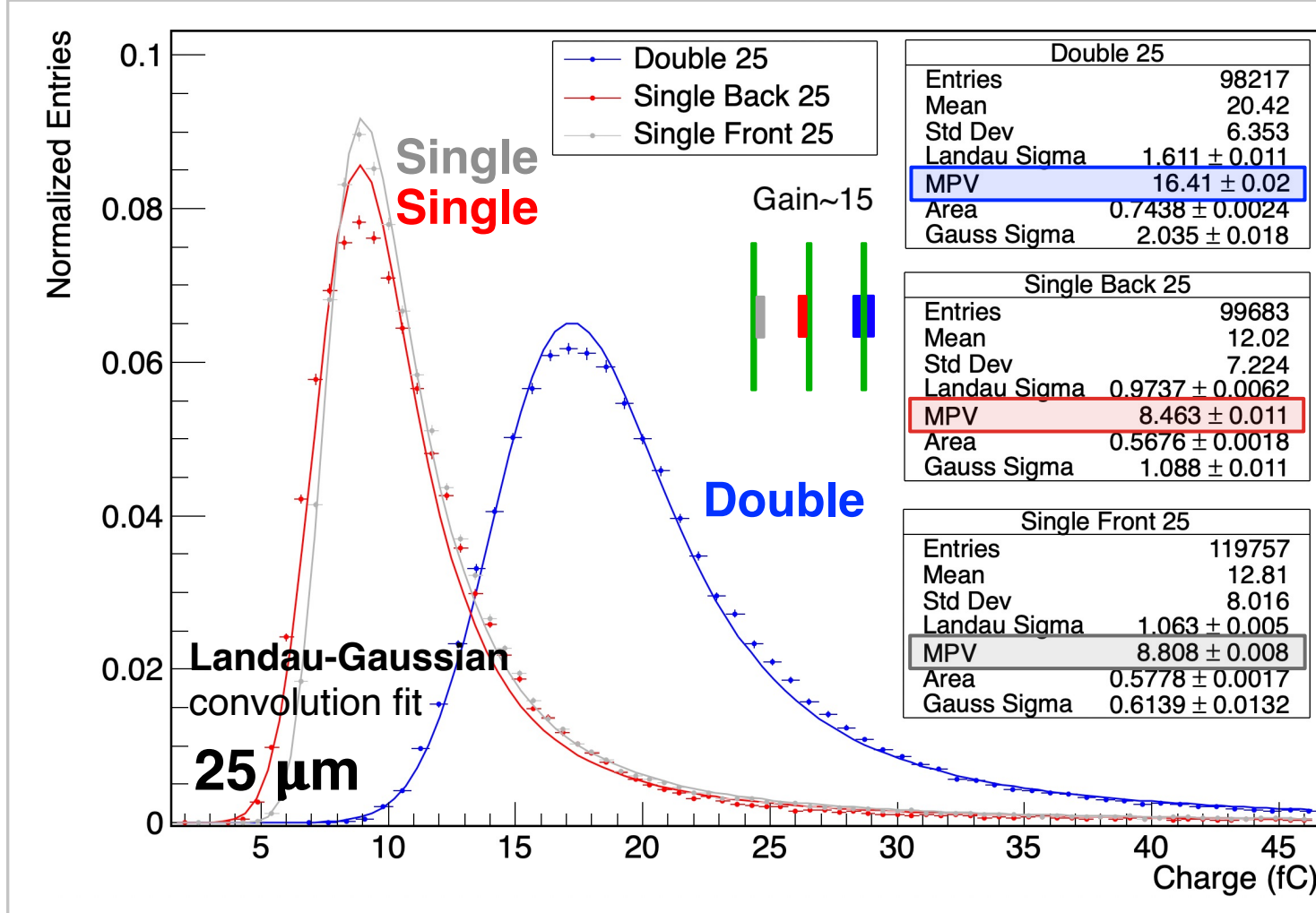
Two uniform LGADs attached to the two sides of the same board, **both connected to the same amplifier**



- **Higher signal**
 - Less power-consuming **front-end electronics**
 - Electronics similar to the one used for the standard LGADs (50 μ m)

- **Better time resolution**

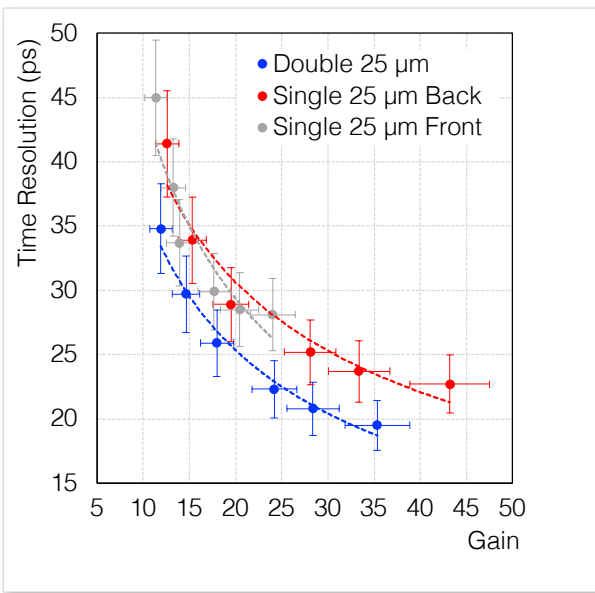




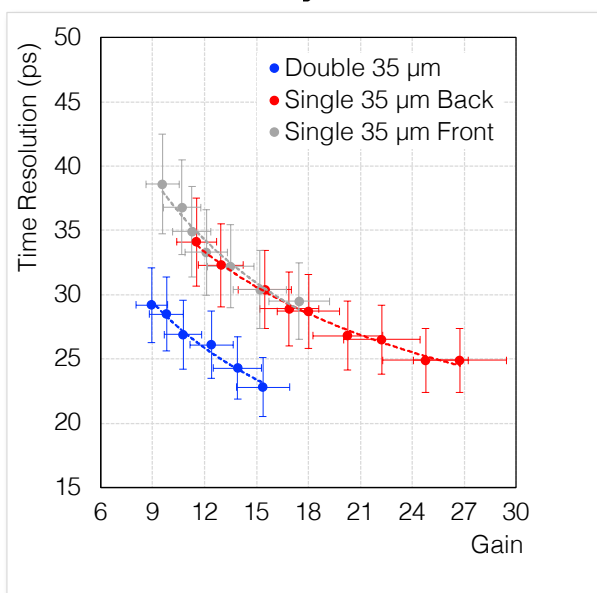
MPV of the charge is **doubled** for the double-LGAD, as expected → **Big advantage for the electronics**

Timing performance: Single VS Double-LGAD

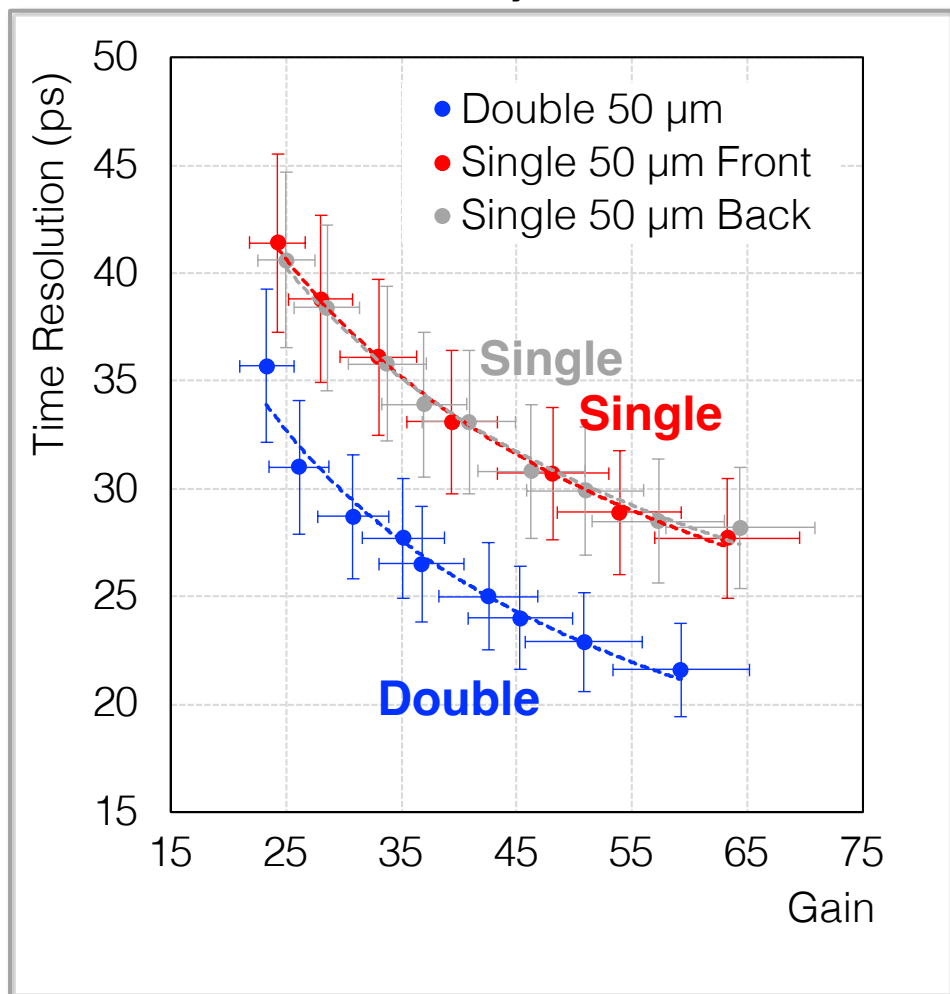
25 μm



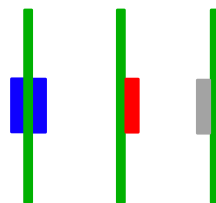
35 μm



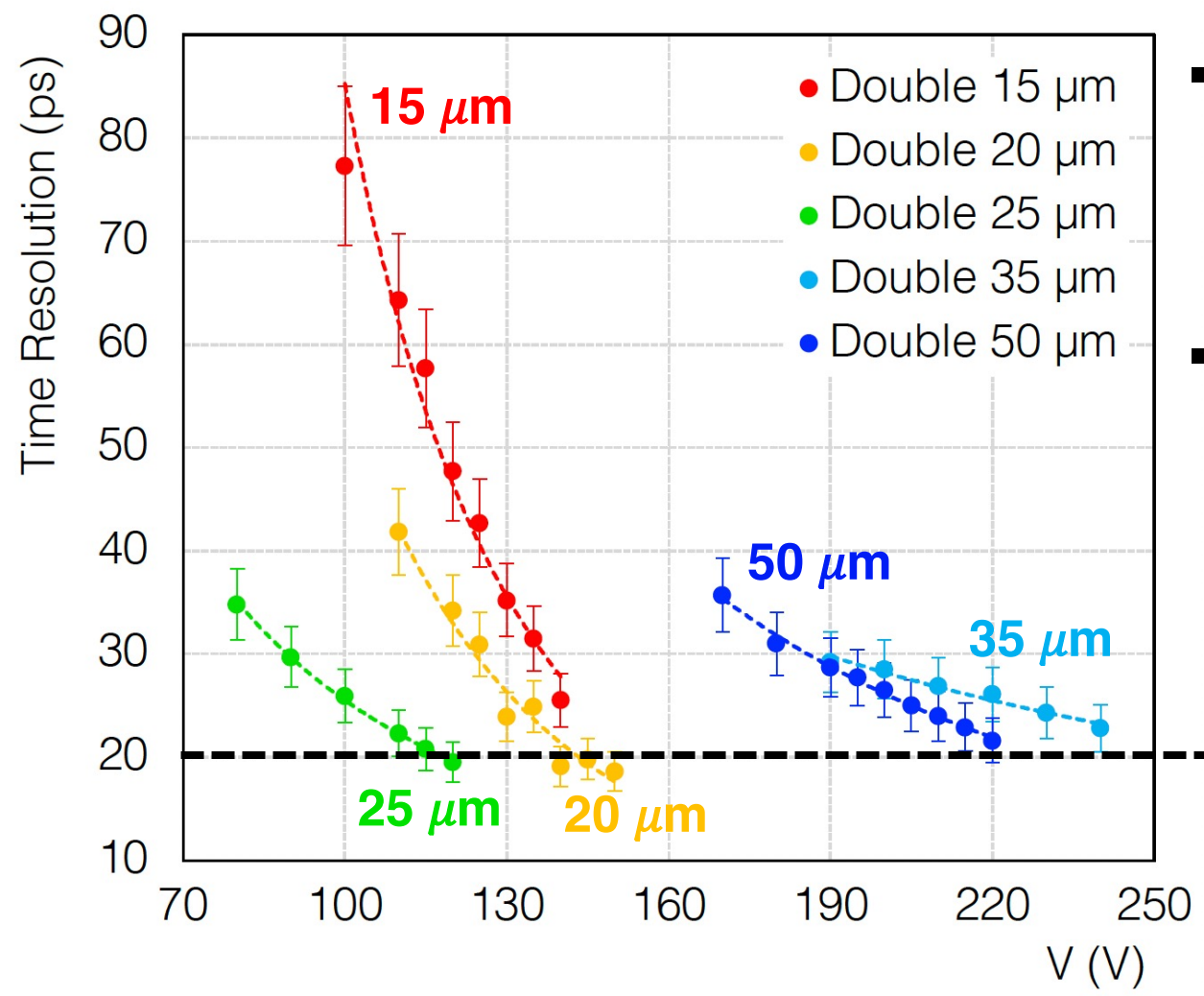
50 μm



- Single LGADs: **comparable** time resolution **for a similar gain**
- **Better time resolution for a double-LGAD** in respect to single ones



Timing performance: Single VS Double-LGAD



- **Double-50 μm** (already existing technology) **compatible with 20 ps**
- Just a **proof of concept**:
 - Thinner prototypes not perfectly identical within the couples
 - **Improvement expected**

Below 20 ps

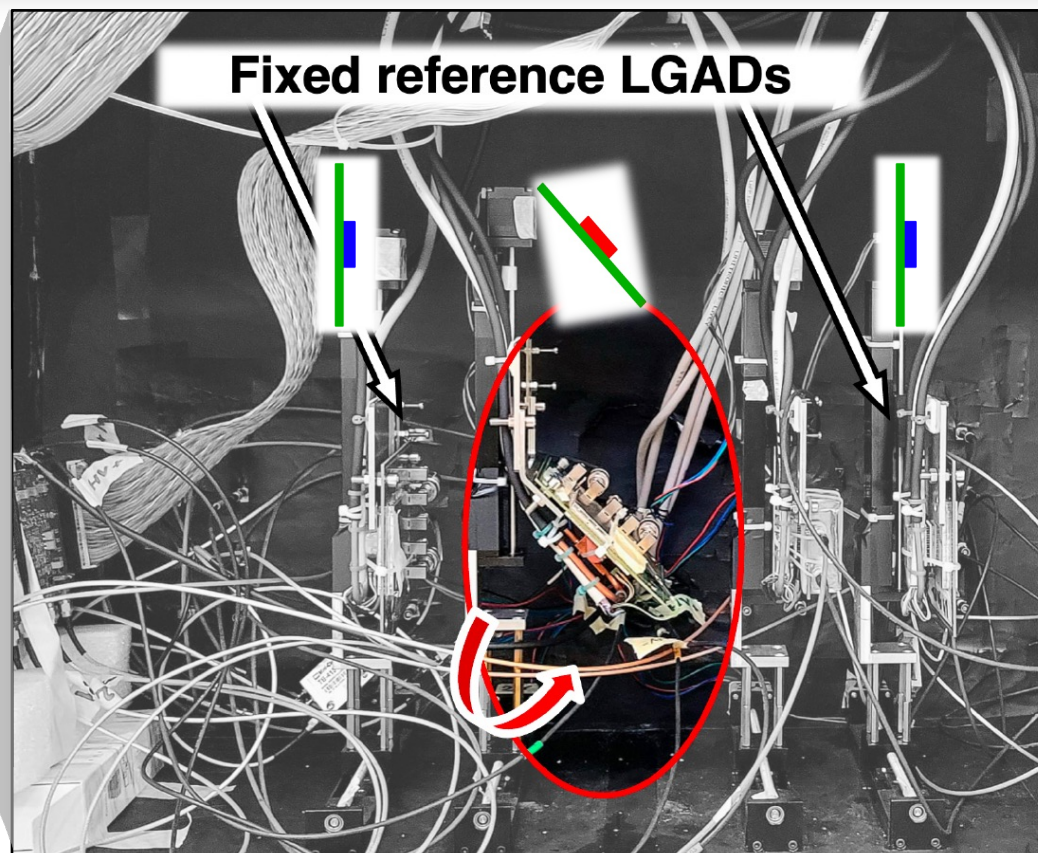
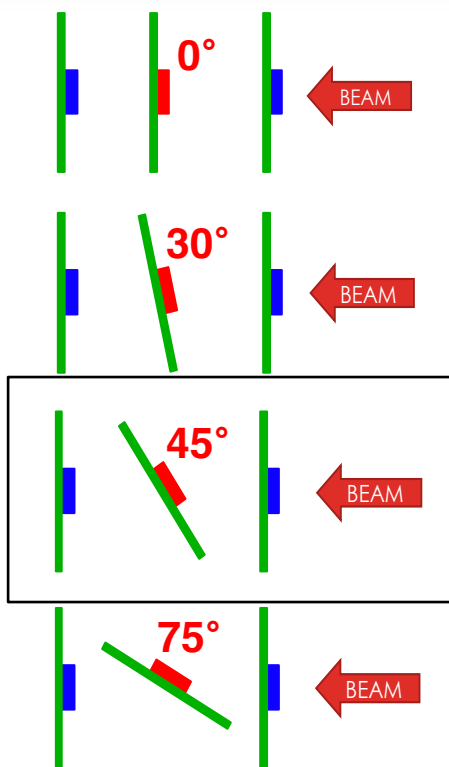


PERFORMANCES WITH INCLINED TRACKS

Changes in the response of sensors placed at the **edge of the barrel layer** or not fully traversed by **particles with very low momentum?**

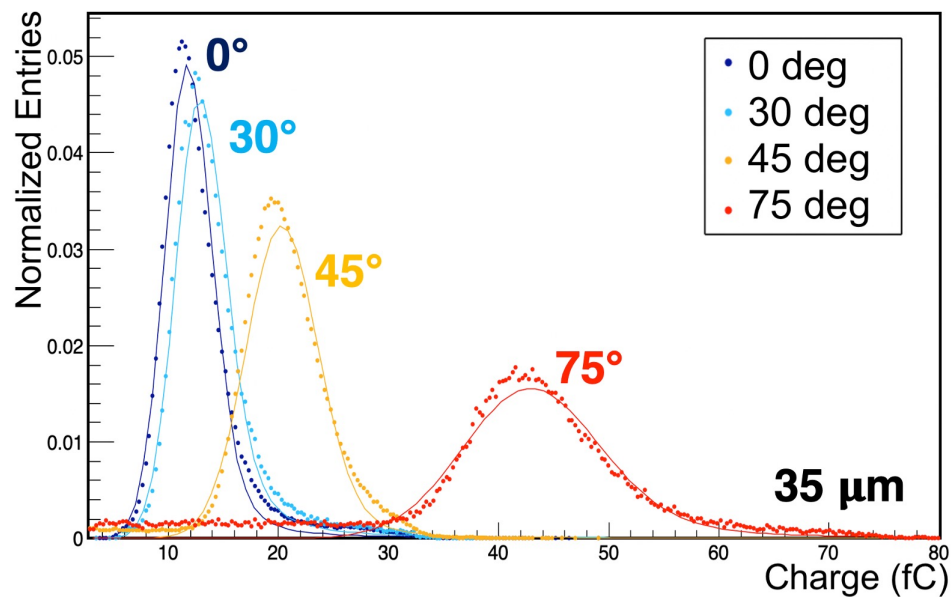
Concurrent effects:

- Longer traversed path, so **more charge** produced
- Part of charge released at the **edges**

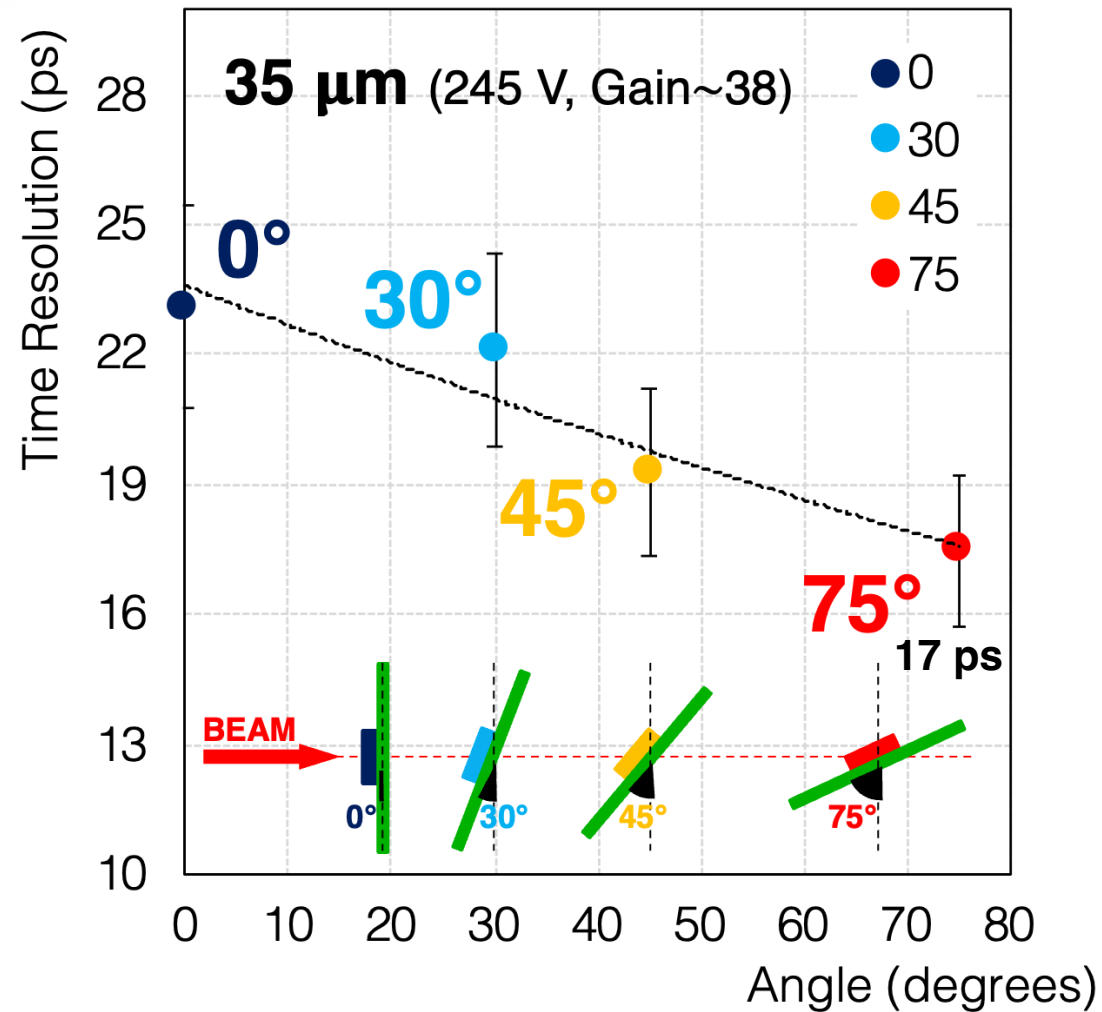


PERFORMANCES WITH INCLINED TRACKS

The **time resolution** slightly **improves** going to **higher** impinging **angles**



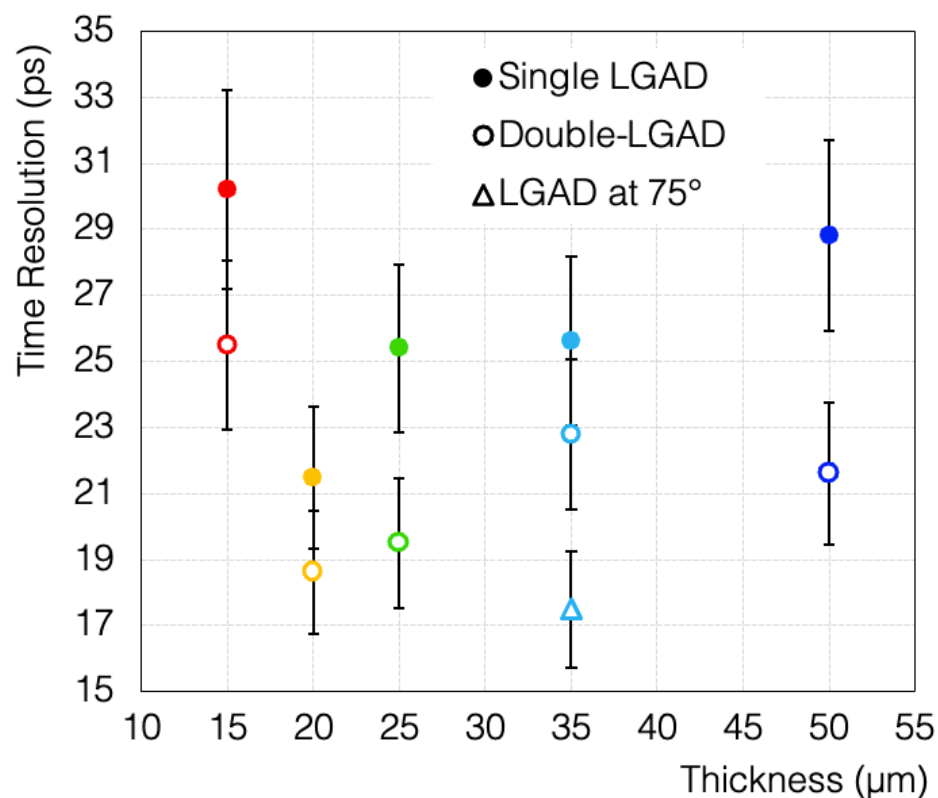
Longer path $\rightarrow$ **higher charge** release



HYBRID LGAD

Outstanding performances in different layouts and implementations

Time res. **in line with** the needs of **ALICE 3** TOF

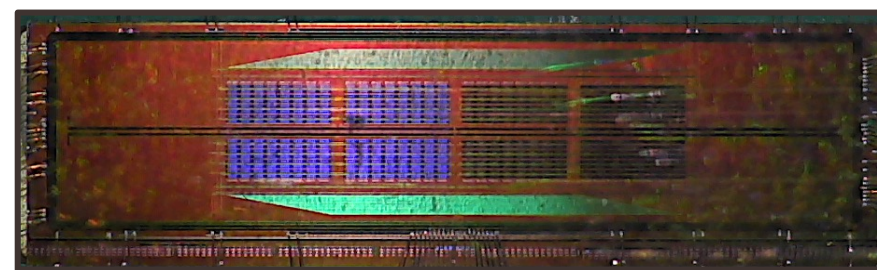


CMOS-LGAD

Combining the LGAD principle with a monolithic approach can provide:

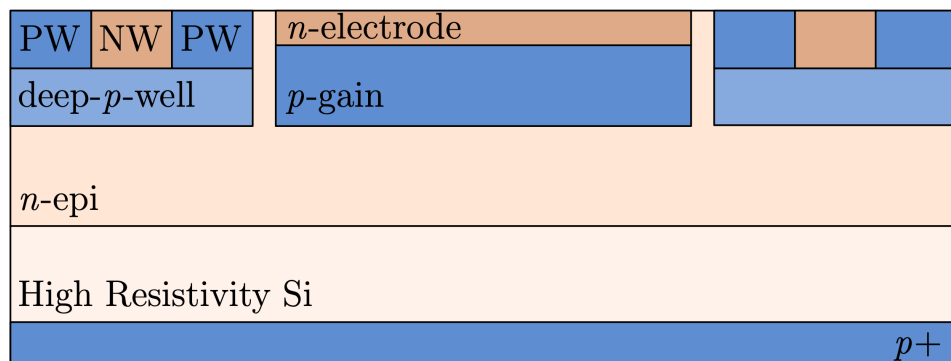
Lower material budget and costs

Simpler and cheaper assembly



→ **Baseline solution**

CMOS-LGAD CONCEPT

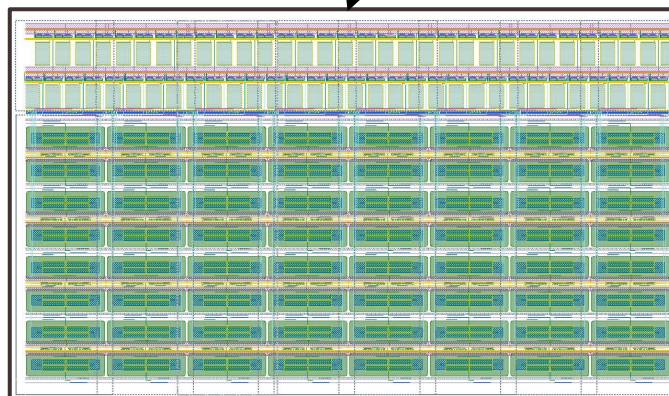
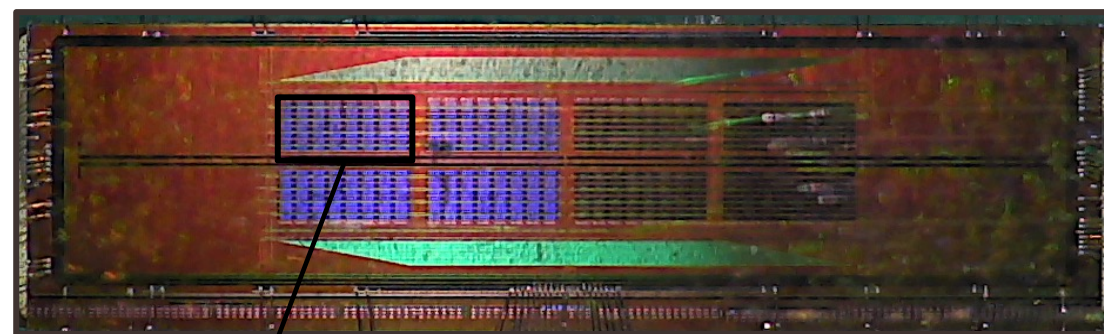


Produced by LFoundry standard 110 nm CMOS process, within the INFN ARCADIA project

Adding a **p-gain below the collecting electrode**

- V_{top} to control the gain
- V_{back} to deplete the sensor

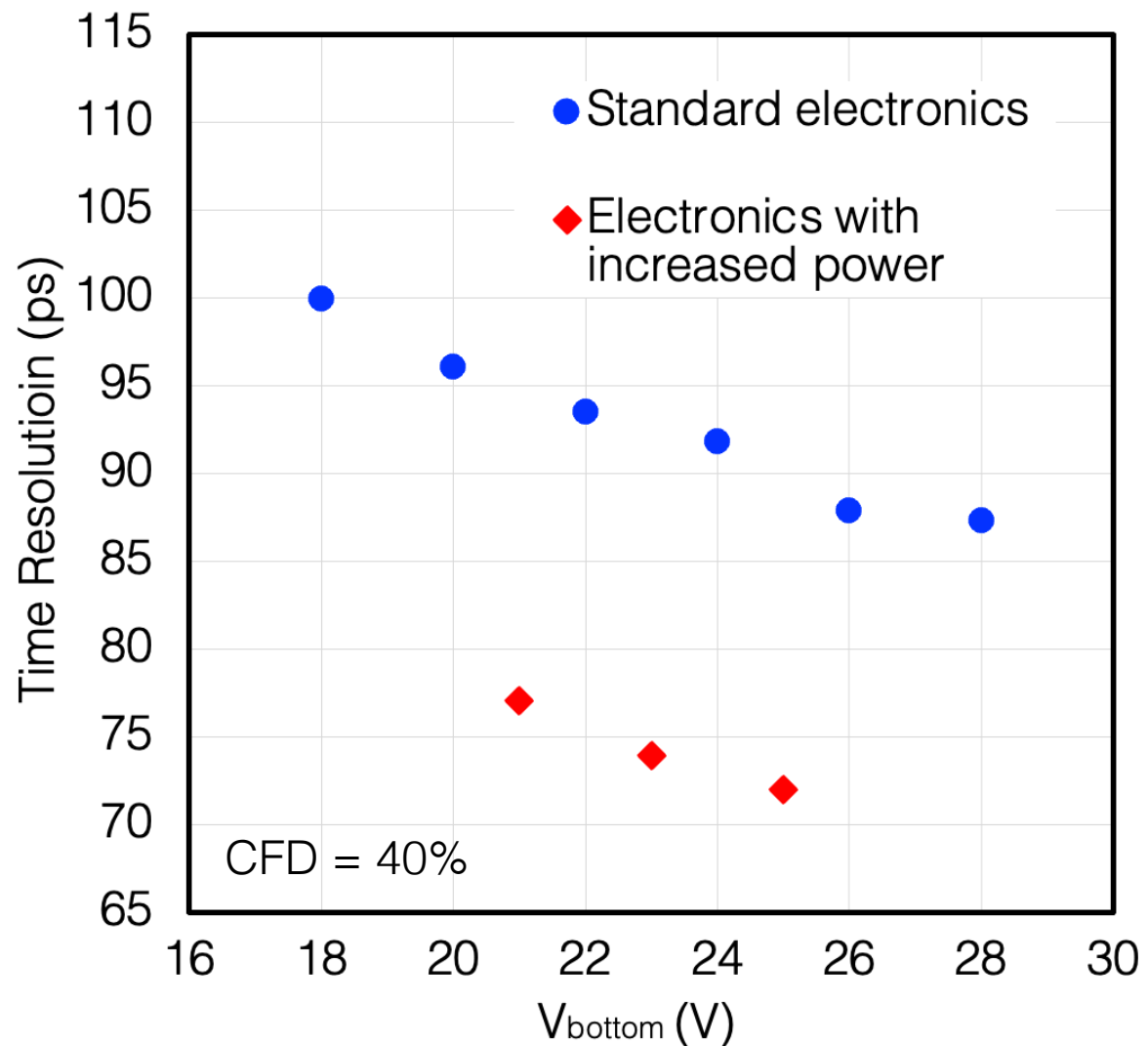
MadPix: Monolithic CMOS Avalanche Detector **PIXelated Prototype for ps timing applications**



First small-scale (4×16 mm²) prototype

- 8 matrices
- 64 pixels per matrix
- $A_{pixel}=250 \times 100 \mu m^2$

TIME RESOLUTION OF CMOS-LGADS



First 48 μm thick CMOS-LGADs with an internal gain of $\approx 7-11$ were tested in a beam test

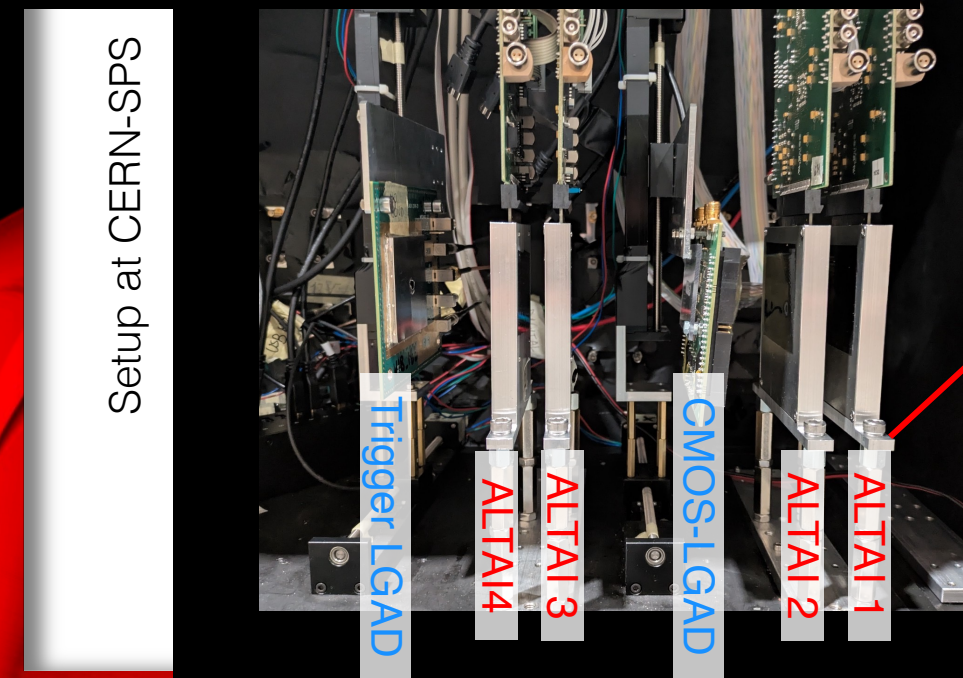
- Time resolution $\approx$ **88 ps**
(Electronics in standard conditions + Sensor)
- ◆ Time resolution of the sensor with increased power on the electronics below **75 ps**

TEST BEAM WITH A TRACKING TELESCOPE

- ◆ **Efficiency** map
- ◆ **Time resolution** vs impinging position correlation

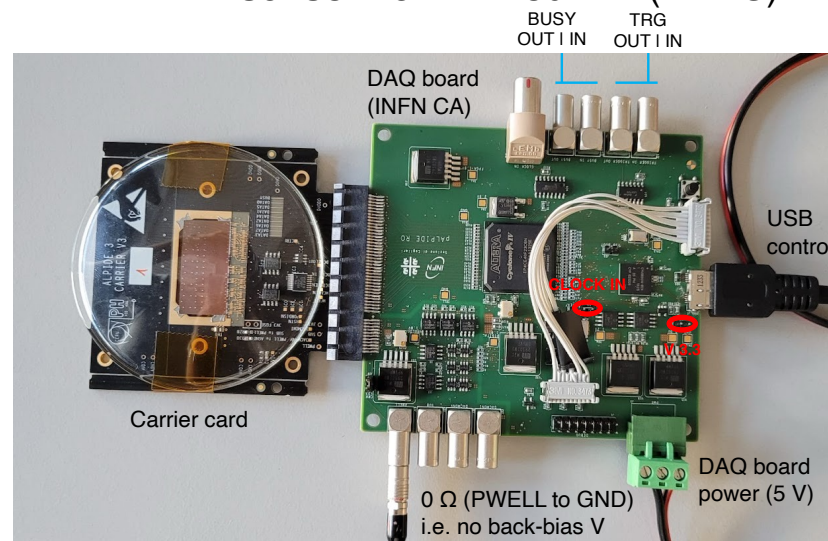


Setup at DESY



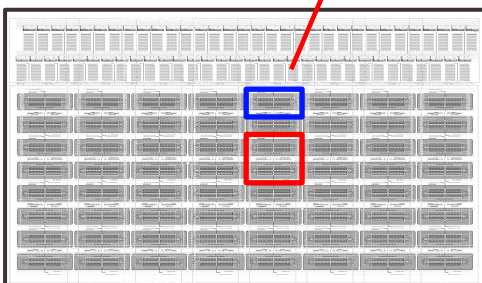
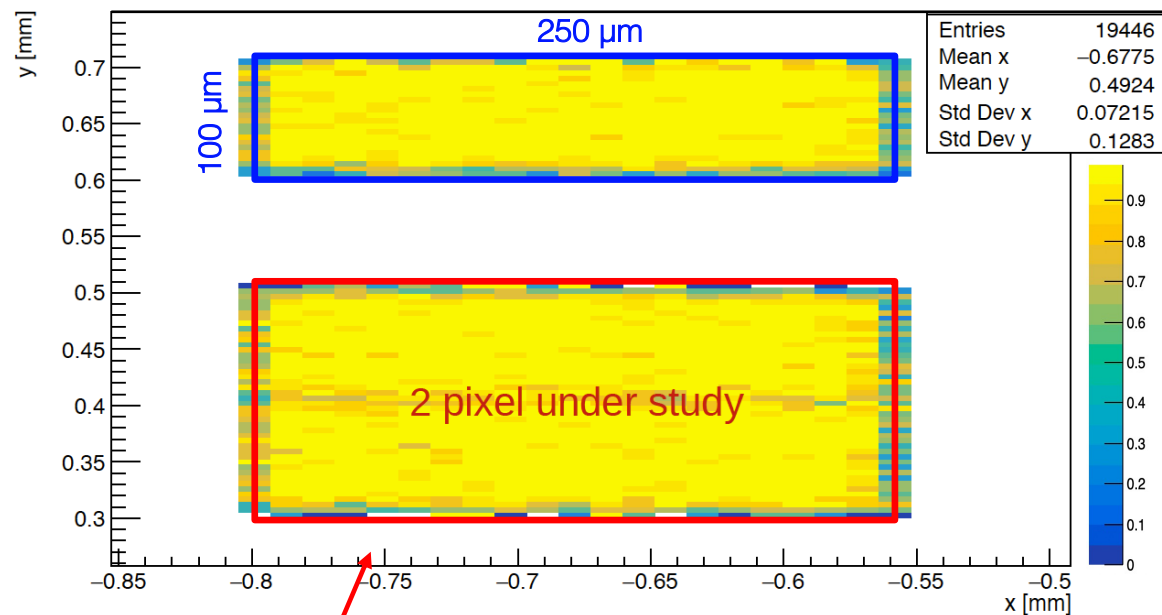
Setup at CERN-SPS

ALTAI sensor 15 mm x 30 mm (MAPS)



Derivation of the ALPIDE chip with a limited threshold range

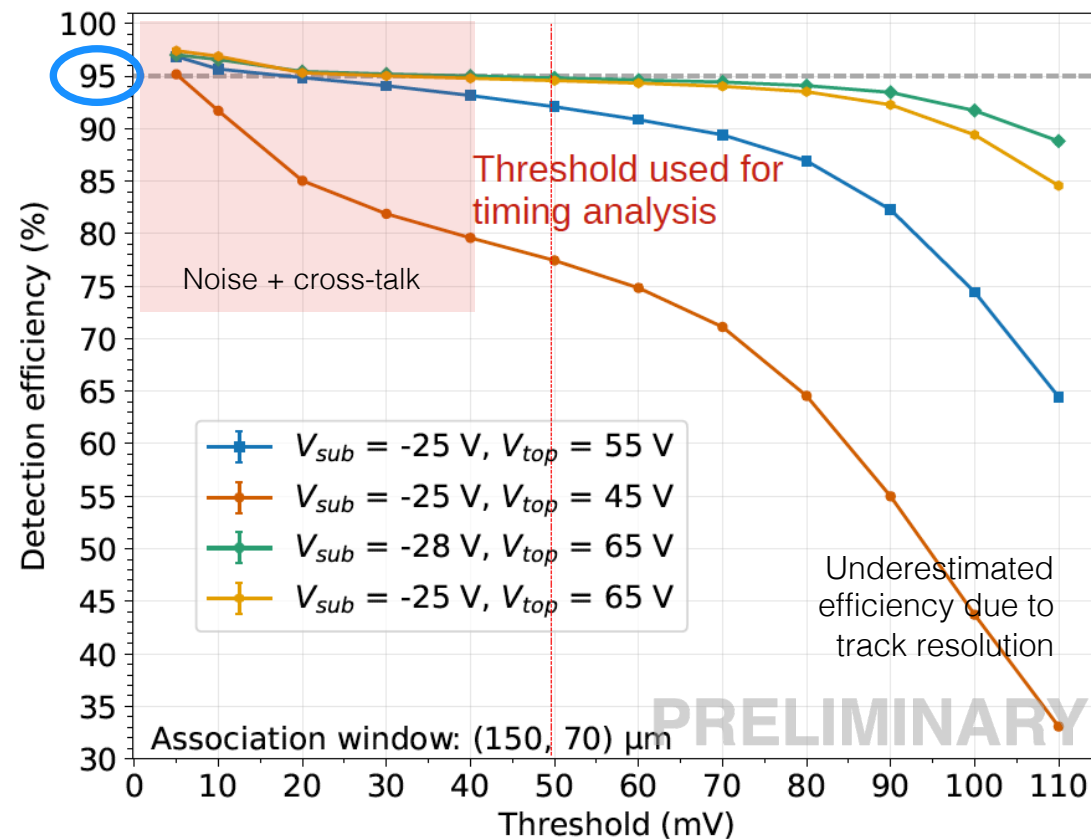
~ **3-5 μm** of tracking resolution expected on the DUTs

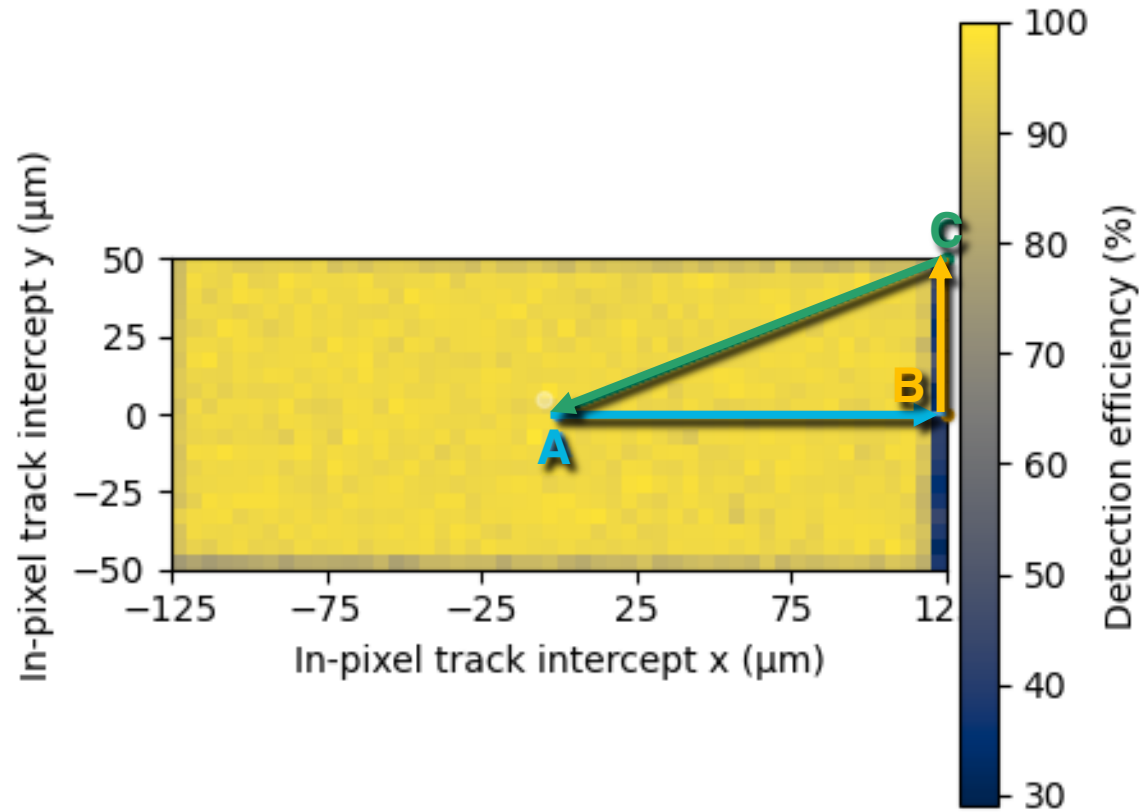


**Efficiency
increases with
higher top V**

(Electronics noise: 1mV, cross-talk <20ps)

Global efficiency VS threshold

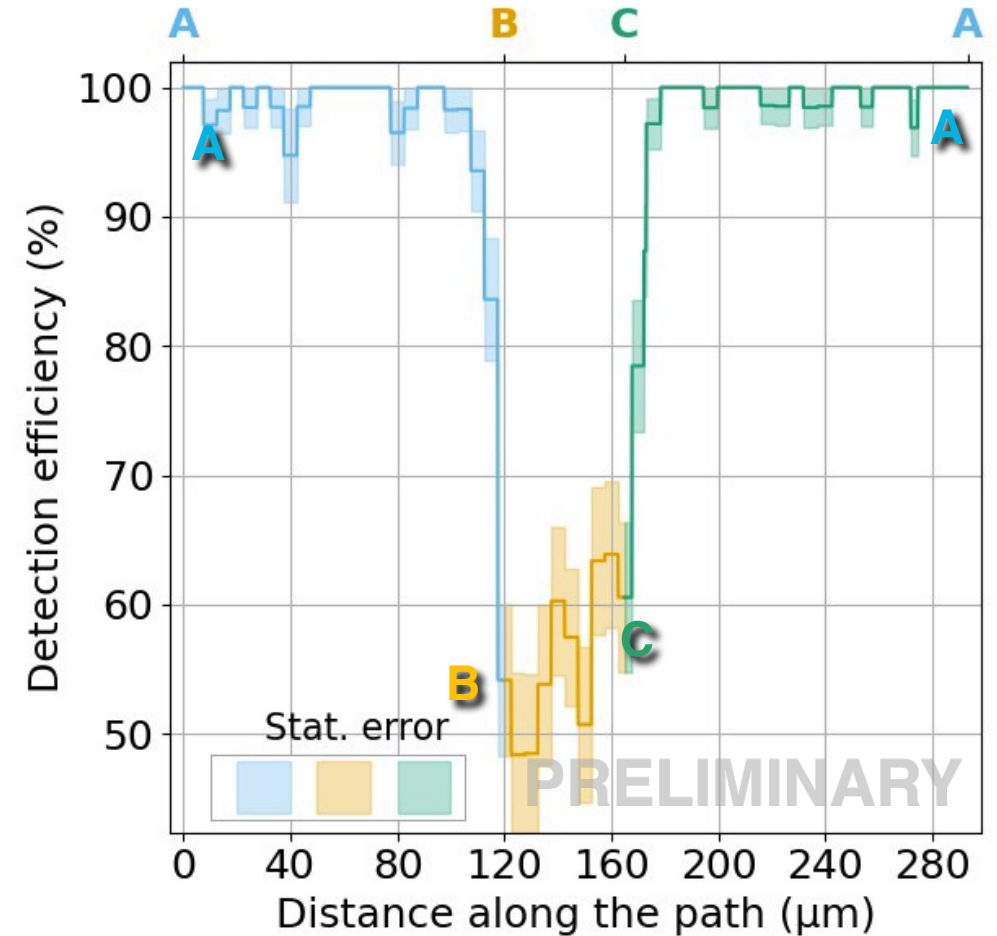




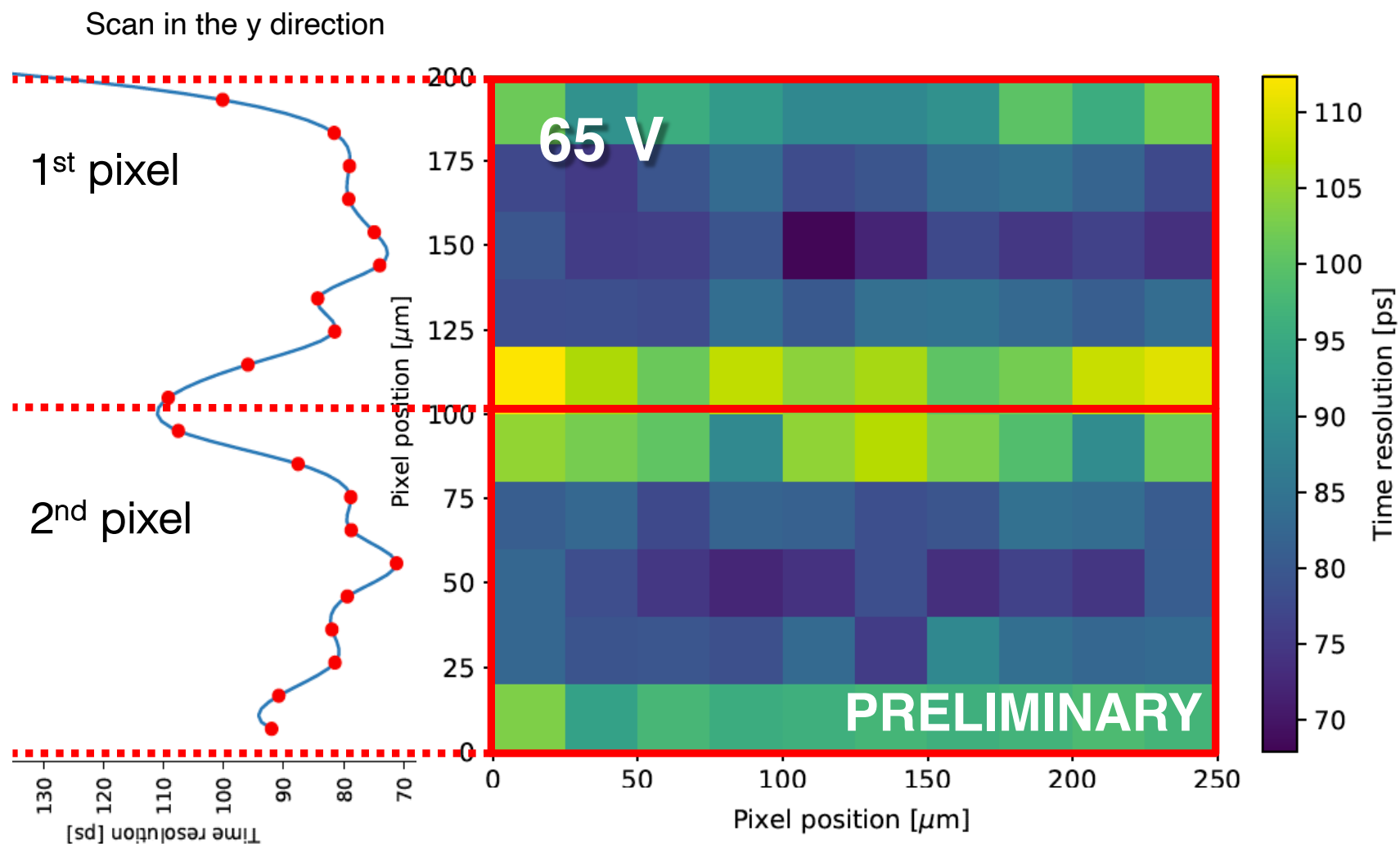
Efficiency drop beneath the pixel border

(Underestimated efficiency at the border due to track resolution)

In-pixel efficiency



CMOS-LGAD TIME RESOLUTION



- ♦ The **best time resolution is at the pixel center** (more uniform E_{field})
- ♦ 75 ps achieved in the standard config.: **no non-Gaussian tails present**

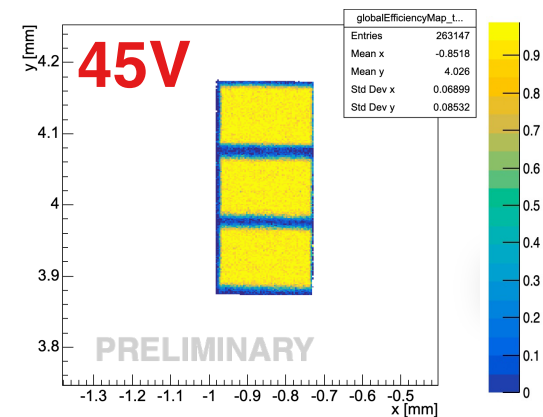
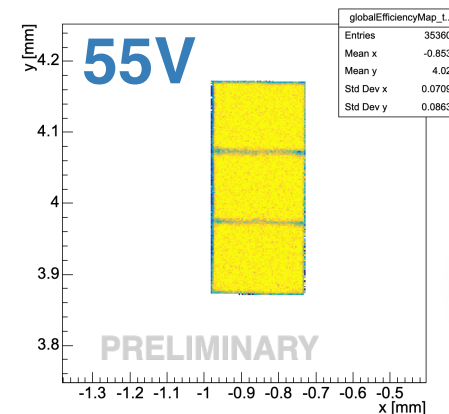
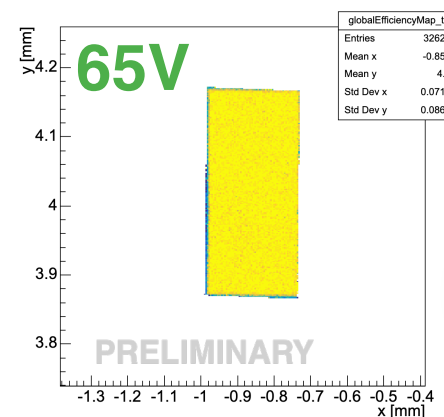
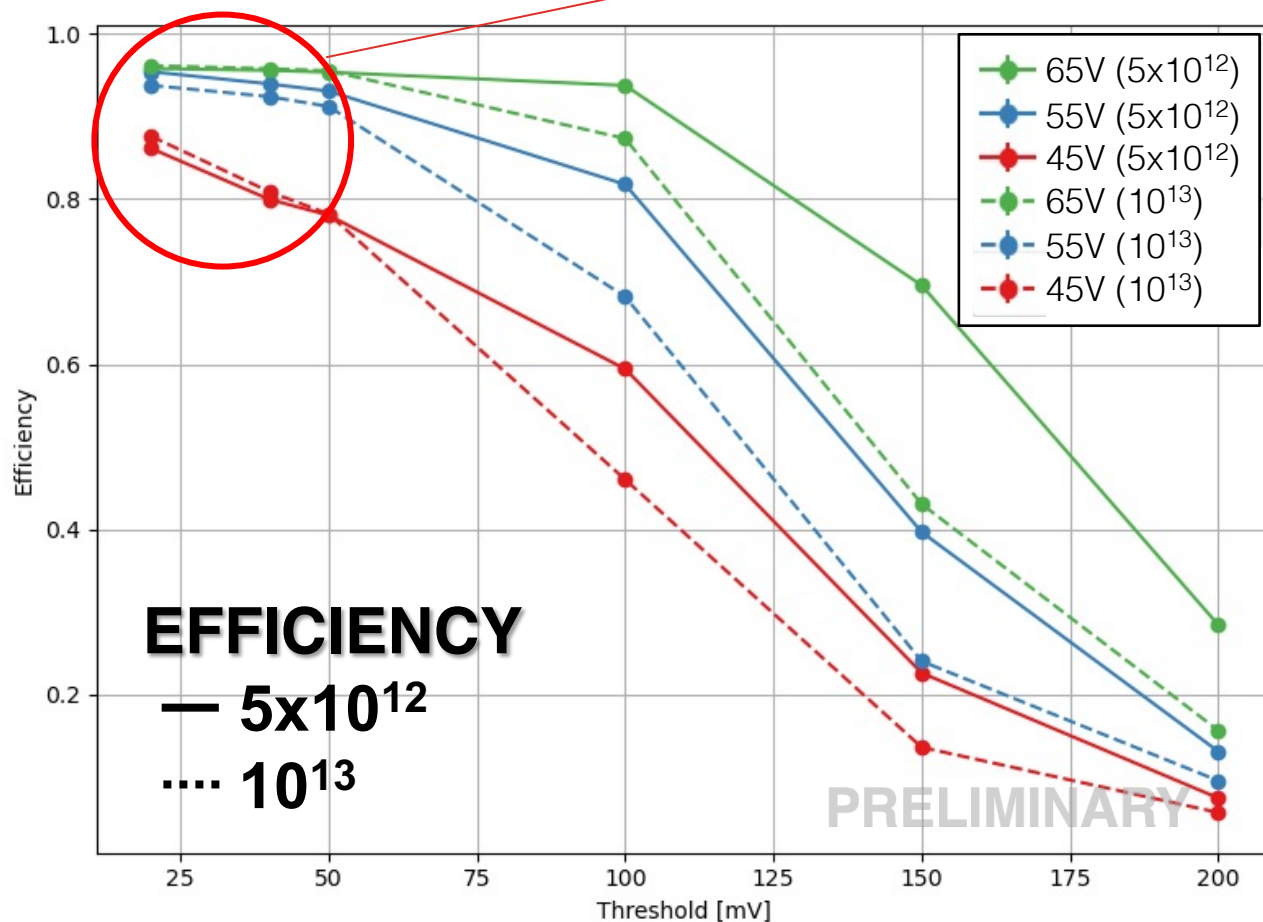
IRRADIATION CAMPAIGN

5 different fluences --- 5×10^{12} , 10^{13} , 5×10^{13} , 10^{14} , 10^{15} MeV n_{eq}/cm^2

***REQUIREMENT
FOR ALICE3 TOF**



Compatible efficiency and **no sign of degradation with irradiation**



♦ Hybrid LGADs

The R&D campaign on resulted in sensors with a time resolution in line with the needs of ALICE 3 TOF

20 ps with different layouts and implementations tested

📌 **Solid backup solution**

♦ CMOS-LGADs

Time resolution in line with the simulations, and efficiency >95%

75 ps → **state-of-the-art for CMOS sensors**

From simulation thinner sensors with a higher gain are expected to reach better results in line with the ALICE 3 TOF

Many ongoing studies to **fully unlock the potential of these technologies**

ACKNOWLEDGEMENTS

The measurements leading to these results have been performed at the Test Beam Facility at DESY Hamburg (Germany), a member of the Helmholtz Association (HGF).

The research leading to these results has received funding from the European Union's Horizon Europe research and innovation programme under grant agreement no.101057511.